

MP0115



IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

Inventor: Sutardja, Sehat

Group Art Unit: 2826

Serial No.: 09/966,914

Examiner: Williams,
Alexander O.

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Title: Improved Integrated Chip Package Having Intermediate Substrate

CERTIFICATE OF MAILING

I hereby certify that this correspondence, and the documents attached hereto, are being deposited with the United States Postal Service as First Class mail in an envelope addressed to Assistant Commissioner for Patents, Washington, D.C. 20231 on this date

Date: July 7, 2003

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Form Letters 1



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